

ULTRA LOW CAPACITANCE TVS ARRAY



DESCRIPTION

The GBLCxxCIDFN Series are ultra low capacitance transient voltage suppressor arrays, designed to protect applications such as portable electronics and SMART phones. These devices are available in a bidirectional configuration and are rated at 250 Watts for an 8/20 μ s waveshape.

The GBLCxxCIDFN Series meets IEC 61000-4-2 (ESD) and IEC 61000-4-4 (EFT) requirements. At higher operating frequencies or faster edge rates, insertion loss and signal integrity are a major concern. These devices offer ultra low capacitance and low leakage current in a miniature DFN-2 package.

FEATURES

- Compatible with IEC 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
Exceeds Level 4: Handles 10kV Contact & 25kV Air Discharge
- Compatible with IEC 61000-4-4 (EFT): 40A - 5/50ns
- 250 Watts Peak Pulse Power per Line (tp = 8/20 μ s)
- Replacement for MLV (0805)
- Bidirectional Configuration
- Protects One Power or I/O Port
- ESD Protection > 25kV
- Available in Multiple Voltages
- Low Clamping Voltage
- Ultra Low Capacitance: 0.6pF (Typical)
- RoHS Compliant
- REACH Compliant

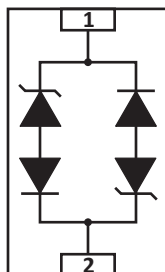
APPLICATIONS

- Ethernet 10/100/1000 Base T
- SMART Phones
- Handheld - Wireless Systems
- USB Interface

MECHANICAL CHARACTERISTICS

- Molded JEDEC DFN-2 Package
- Approximate Weight: 0.8 milligrams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:
Pure-Tin - Sn, 100: 260-270°C
- 8mm Tape and Reel Per EIA Standard 481
- Flammability Rating UL 94V-0
- Patent Pending

PIN CONFIGURATION



TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified

PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power (tp = 8/20μs) - See Figure 1	P _{PP}	250	Watts
Operating Temperature	T _A	-55 to 150	°C
Storage Temperature	T _{STG}	-55 to 150	°C

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified

PART NUMBER	DEVICE MARKING	RATED STAND-OFF VOLTAGE V _{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA V _(BR) VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ IP = 1A V _C VOLTS	MAXIMUM LEAKAGE CURRENT @ V _{WM} I _D μA	TYPICAL CAPACITANCE @ 0V, 1MHz C pF
GBLC03CIDFN	CC	3.0	4.0	7.0	1	0.6
GBLC05CIDFN	FC	5.0	6.1	8.0	5	0.6

TYPICAL DEVICE CHARACTERISTICS

FIGURE 1
PEAK PULSE POWER VS PULSE TIME

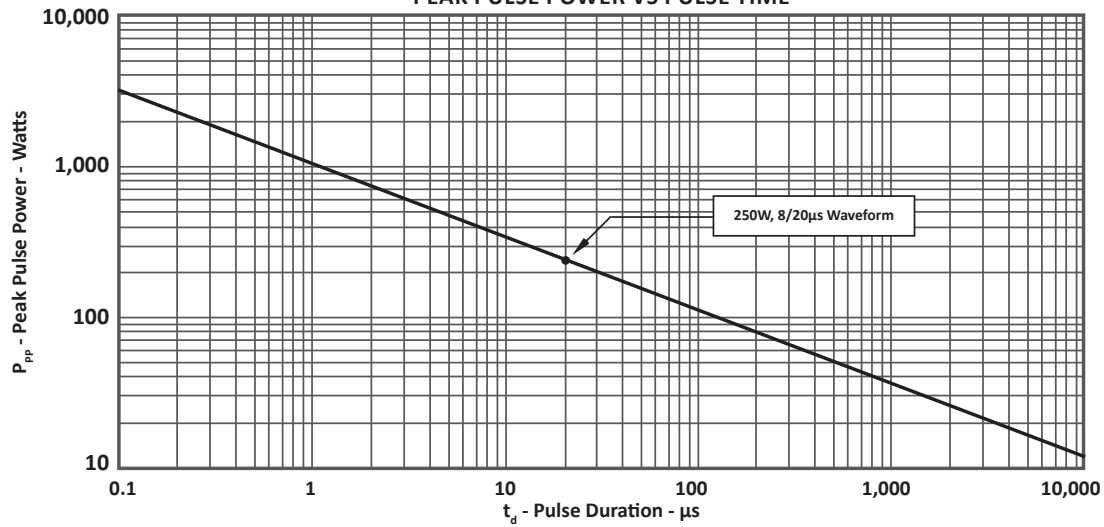
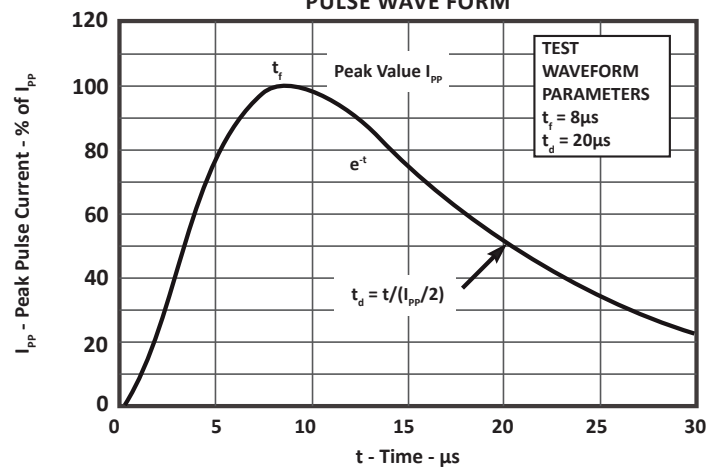
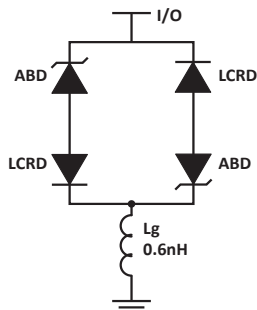


FIGURE 2
PULSE WAVE FORM



SPICE MODEL

FIGURE 1
SPICE MODEL


ABD - Avalanche Breakdown Diode (TVS)
 LCRD: Low Capacitance Rectifier Diode
 Lg - Lead Inductance

TABLE 1 - SPICE PARAMETERS

PARAMETER	UNIT	ABD(TVS)	LCRD
BV	V	See Table 2	100
IBV	μA	1	0.5
C_{jo}	pF	See Table 2	0.3
I_s	A	See Table 2	1E-11
Vj	V	0.6	0.6
M	-	0.33	0.33
N	-	1	1
R_s	Ohms	See Table 2	0.75
TT	s	1E-8	1E-9
EG	eV	1.11	1.11

TABLE 2 - ABD SPECIFIC SPICE PARAMETERS

PART NUMBER	B_V (VOLTS)	C_{jo} (pF)	I_s (AMPS)	R_s (OHMS)
GBLC03CIDFN	4.0	200	1E-11	0.22
GBLC05CIDFN	6.1	200	1E-11	0.22

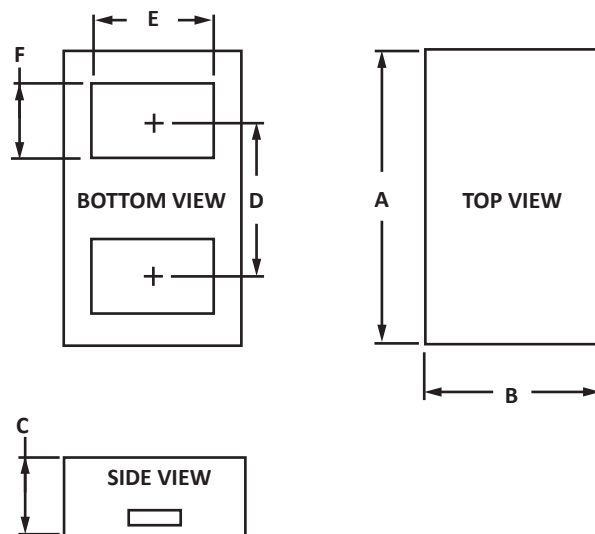
PACKAGE INFORMATION

OUTLINE DIMENSIONS

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.43	1.57	0.056	0.062
B	1.13	1.27	0.044	0.050
C	0.51	0.61	0.020	0.024
D	0.75 BSC		0.029 BSC	
E	0.79	0.89	0.030	0.036
F	0.39	0.47	0.015	0.019

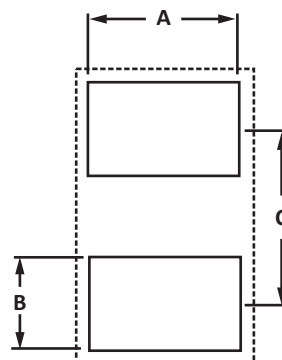
NOTES

1. Controlling dimension: millimeters.
2. Dimensioning and tolerances per ANSI Y14.M, 1985.

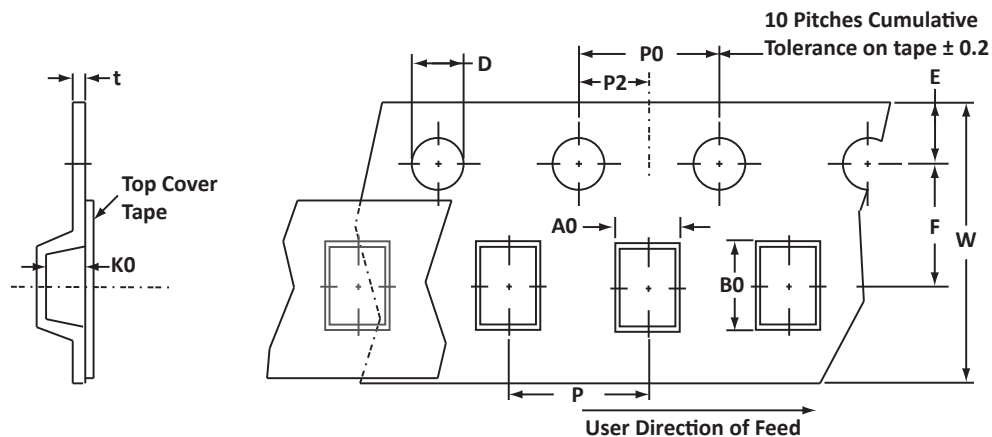


PAD LAYOUT

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.93	1.05	0.036	0.042
B	0.52	0.60	0.020	0.024
C	0.76 BSC		0.030 BSC	



TAPE AND REEL



SPECIFICATIONS

REEL DIA.	TAPE WIDTH	A0	B0	K0	D	E	F	W	P0	P2	P	tmax
178mm (7")	8mm	0.61 ± 0.10	1.68 ± 0.10	0.68 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	0.25

NOTES

- Dimensions are in millimeters.
- Surface mount product is taped and reeled in accordance with EIA-481.
- Suffix - T75 = 7" Reel - 5,000 pieces per 8mm tape.
- Marking on Part - marking code (see page 2).

ORDERING INFORMATION

BASE PART NUMBER (xx = Voltage)	LEADFREE SUFFIX	TAPE SUFFIX	QTY/REEL	REEL SIZE	TUBE QTY
GBLCxxCIDFN	n/a	-T75	5,000	7"	n/a

This device is only available in a Lead-Free configuration.

COMPANY INFORMATION

COMPANY PROFILE

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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